

Switching Diode

BAS16HT1

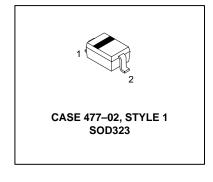
ON Semiconductor Preferred Device

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	V _R	75	Vdc
Peak Forward Current	ΙF	200	mAdc
Peak Forward Surge Current	I _{FM(surge)}	500	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit			
Total Device Dissipation FR-5 Board,* TA = 25°C Derate above 25°C	PD	200 1.57	mW mW/°C			
Thermal Resistance Junction to Ambient	$R_{ heta JA}$	635	°C/W			
Junction and Storage Temperature	TJ, T _{stg}	150	°C			



1 O 2 CATHODE ANODE

DEVICE MARKING

BAS16HT1 = A6

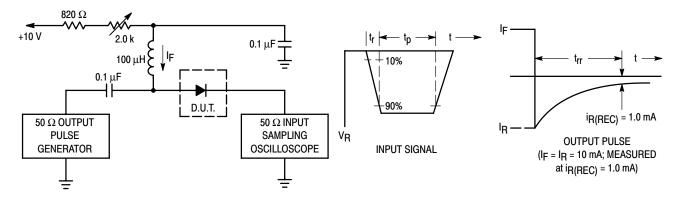
ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit		
OFF CHARACTERISTICS						
Reverse Voltage Leakage Current (V _R = 75 Vdc) (V _R = 75 Vdc, T _J = 150°C) (V _R = 25 Vdc, T _J = 150°C)	I _R	_ _ _	1.0 50 30	μAdc		
Reverse Breakdown Voltage (I _{BR} = 100 μAdc)	V(BR)	75	_	Vdc		
Forward Voltage (IF = 1.0 mAdc) (IF = 10 mAdc) (IF = 50 mAdc) (IF = 150 mAdc)	VF	_ _ _ _	715 855 1000 1250	mV		
Diode Capacitance (V _R = 0, f = 1.0 MHz)	C _D	_	2.0	pF		
Forward Recovery Voltage (IF = 10 mAdc, t _r = 20 ns)	V _{FR}	_	1.75	Vdc		
Reverse Recovery Time (IF = IR = 10 mAdc, R _L = 50 Ω)	t _{rr}	_	6.0	ns		
Stored Charge (IF = 10 mAdc to V_R = 5.0 Vdc, R_L = 500 Ω)	QS	_	45	pC		

Preferred devices are ON Semiconductor recommended choices for future use and best overall value.

^{*}FR-4 Minimum Pad

BAS16HT1



Notes: 1. A 2.0 k Ω variable resistor adjusted for a Forward Current (IF) of 10 mA.

- 2. Input pulse is adjusted so I_{R(peak)} is equal to 10 mA.
- 3. tp » trr

Figure 1. Recovery Time Equivalent Test Circuit

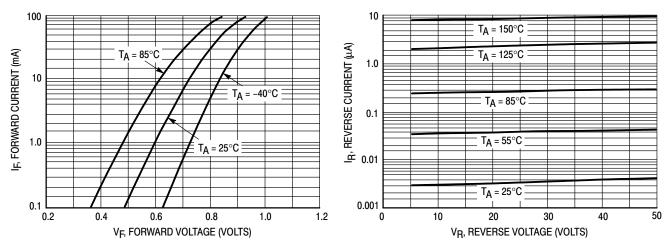


Figure 2. Forward Voltage

Figure 3. Leakage Current

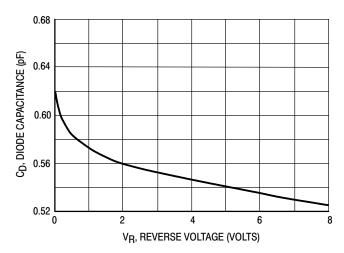
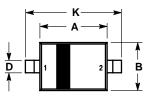


Figure 4. Capacitance

BAS16HT1

PACKAGE DIMENSIONS

SOD-323 CASE 477-02 **ISSUE B**





- NOTES:

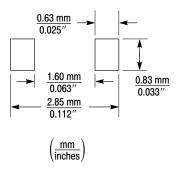
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.

	MILLIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	1.60	1.80	0.063	0.071	
В	1.15	1.35	0.045	0.053	
С	0.80	1.00	0.031	0.039	
D	0.25	0.40	0.010	0.016	
Е	0.15 REF		0.006 REF		
Н	0.00	0.10	0.000	0.004	
J	0.089	0.177	0.0035	0.0070	
К	2.30	2 70	0.091	0 106	

STYLE 1: PIN 1. CATHODE 2. ANODE



SOD-323 Soldering Footprint

BAS16HT1

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